




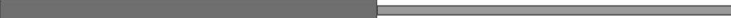

















Board Stack Report

Stack Up			Layer Stack			
Layer	Board Layer Stack	Flex	Name	Material	Thickness	Constant
1			Top Paste			
2			Top Overlay			
3			Top Solder	Solder Resist	0.010mm	3.5
4			Top Layer	Copper	0.036mm	
5			Dielectric 1	PP-017	0.130mm	4.3
6			Layer 1	Copper	0.035mm	
7			Dielectric 2.1	PP-017	0.130mm	4.3
8			Dielectric 2.2	Core-025	0.203mm	4.6
9			Layer 2	Copper	0.035mm	
10			Dielectric 3.1	PP-017	0.130mm	4.3
11			Dielectric 3.2	PP-017	0.130mm	4.3
12			Layer 3	Copper	0.035mm	
13			Dielectric 4	Core-025	0.203mm	4.6
14			Layer 4	Copper	0.035mm	
15			Dielectric 5.2	PP-017	0.130mm	4.3
16			Dielectric 5.1	PP-017	0.130mm	4.3
17			Layer 5	Copper	0.035mm	
18			Dielectric 6.2	Core-025	0.203mm	4.6
19			Dielectric 6.1	PP-017	0.130mm	4.3
20			Layer 6	Copper	0.035mm	
21			Dielectric 7	PP-017	0.130mm	4.3
22			Bottom Layer	Copper	0.036mm	
23			Bottom Solder	Solder Resist	0.010mm	3.5
24			Bottom Overlay			
25			Bottom Paste			
	Height : 1.688mm	Height : 0.931mm				